

January 30, 2003

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231
ATTN: Group Art Unit 2815 J. R. Diaz
From: Stephen B. Ackerman, Reg. No. 37,761
20 McIntosh Drive
Poughkeepsie, N. Y. 12603

Serial No. 09/764,242 01/19/2001

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A FILL PATTERN IN KERF AREAS TO PREVENT LOCALIZED
NON-UNIFORMITIES OF INSULATING LAYERS AT DIE
CORNERS ON SEMICONDUCTOR SUBSTRATES

Group Art Unit: 2815 J. R. Diaz

RESPONSE TO PATENT OFFICE ACTION

Dear Sir or Madam:

The Commissioner is hereby authorized to charge payment of
any additional fees involved with added Claims and the like
to Deposit Account No. 19-0033.

In response to Office Action dated December 3, 2002, please
consider the following remarks.

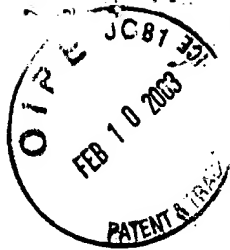
CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited
with the U. S. Postal Service as first class mail in an
envelope addressed to: Commissioner of Patents and
Trademarks, Washington, D.C. 20231, on February 3, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature

Date 2/3/03



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FEB 13 2003

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2/25/03